

HT82J927A USB Gamepad

Features

- USB 2.0 low speed compliance/USB HID 1.1 compliance
- Operation voltage: 4.2V~5.5V
- · Operation frequency:6MHz
- 12 function buttons
- Mode switch: digital mode or analog mode can changed by switch
- Interface: USB+vibration
- One LED indicator (indicate for digital and analog mode switch)

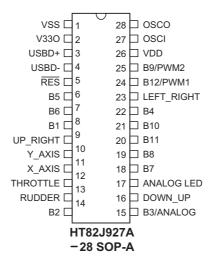
- An 8-way D-pad
- 2 sticks (X-axis Y-axis Throttle Rudder)
- Compatible operation system: Windows 98SE/2000/XP/XP SP1/XP SP2/2000 SERVER/2003 SERVER
- Vibration function (Driver optional install, if has install driver must have installed DirectX7.0 or later version too)
- 28-pin SOP package

General Description

HT82J927A is designed as USB+ Vibration interface gamepad controller, The HT82J927A can easily used via the game controller input function on Windows 98SE/2000/XP/XP SP1/XP SP2/2000 SERVER/2003

SERVER operation systems. It has 12 function buttons, vibration function, one LED indicator, 2 sticks, an 8-way D-pad.

Pin Assignment



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Pin Description

Pin Name	I/O	Description	
B1~B2, B3/ANALOG, B4~B8, B9/PWM2, B10~B11, B12/PWM1	I/O	For 12 function buttons (B9/PWM2, B12/PWM1 pin-shared with PWM1, PWM2 and Vibration function.	
X_AXIS Y_AXIS THROTTLE RUDDER	I/O	For 2 sticks (X-axis, Y-axis, Throttle, Rudder)	
UP_RIGHT LEFT_RIGHT DOWN_UP	I/O	or an 8-way D-pad (Hat switch :UP, DOWN, LEFT, RIGHT)	
ANALOG LED	0	or LED indicator	
VSS	_	legative power supply, ground	
RES	ı	Schmitt trigger reset input, active low.	
VDD	_	Positive power supply	
V33O	0	3.3V regulator output	
USBD+	I/O	USB CLK I/O line	
USBD-	I/O	USB DATA I/O line	
OSCI OSCO	I О	OSCI, OSCO are connected to a 6MHz crystal/resonator (determined by software instructions) for the internal system clock.	

Absolute Maximum Ratings

Supply VoltageV _{SS} -0.3V to V _{SS} +6.0V	Storage Temperature50°C to 125°C
Input VoltageV _{SS} -0.3V to V _{DD} +0.3V	Operating Temperature0°C to 70°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

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D.C. Characteristics

Ta=25°C

Sumb al	Donomotor	Test Conditions		Min.	Тур.	Max.	Unit
Symbol	Parameter		Conditions	IVIII.			
V_{DD}	Operating Voltage	_	_	4.2	_	5.5	V
I _{DD}	Operating Current (6MHz Crystal)	5V	No load, f _{SYS} =6MHz		7	9	mA
I _{STB}	Standby Current	5V	No load, system HALT	_	300	500	μΑ
V _{IL1}	Input Low Voltage for I/O Ports	5V	_	0	_	0.8	V
V _{IH1}	Input High Voltage for I/O Ports	5V	_	2	_	5	V
V _{IL2}	Input Low Voltage (RES)	5V	_	0	_	0.4V _{DD}	V
V _{IH2}	Input High Voltage (RES)	5V	_	0.9V _{DD}	_	V _{DD}	V
I _{OL}	Output Sink Current for Other Ports B1~B2, B3/ANALOG, B4~B8, B9/PWM2, B10~B11, B12/PWM1, X-AXIS, Y-AXIS, THROTTLE and RUDDER	5V	V _{OL} =0.4V	2	4	_	mA
I _{OH}	Output Port Source Current	5V	V _{OH} =3.4V	-2.5	-4	_	mA
V_{LVR}	Low Voltage Reset	5V	_	2.4	2.7	3	V

Note: Reset pins voltage level is CMOS level IO pins voltage level is TTL level

A.C. Characteristics

Ta=25°C

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
	Parameter		Conditions	WIII.			
f _{SYS}	System Clock (Crystal OSC)	5V		_	6	_	MHz
f _{RCSYS}	RC Clock with 8-bit Prescaler Register	5V	_	0	32	_	kHz
t _{WDT}	Watchdog Time-out Period (System Clock)	_	Without WDT prescaler	1024		_	t _{RCSYS}
t _{RF}	USBD+, USBD- Rising & Falling Time	_				300	ns
t _{SST}	System Start-up Timer Period	Wake-up from HALT		_	1024	_	t _{SYS}
tosc	Crystal Setup	_	_	_	5	10	ms
f _{PWM}	PWM Cycle Period Decide by Driver	_	6MHz	_	810	_	Hz

Note: Power-on period= $t_{WDT}+t_{SST}+t_{OSC}$

WDT Time-out in normal mode= $1/f_{RCSYS} \times 256 \times WDTS + t_{WDT}$ WDT Time-out in HALT mode= $1/f_{RCSYS} \times 256 \times WDTS + t_{SST} + t_{OSC}$

Functional Description

Device to PC Command

Byte1: Throttle value Byte3: X-Axis value Byte4: Y-Axis value

Byte5: 00H Byte6: Hat switch and Button1~Button4 value

Byte7: Button 5~Button 12 value

PC to Device Command

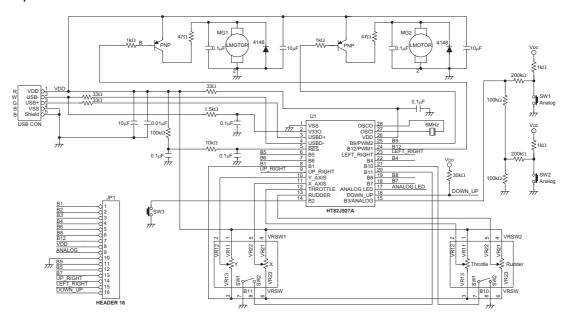
Byte1: Vibration function enable or disable Byte3: Left Vibration function intensity Byte5: Right Vibration function intensity

Wake-up: None

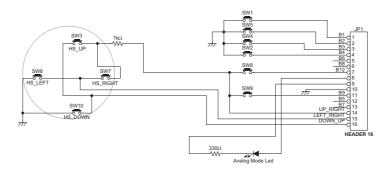


Application Circuits

Top Circuit



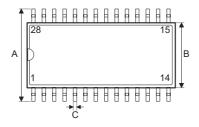
Button Circuit

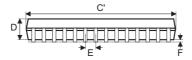


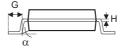


Package Information

28-pin SOP (300mil) Outline Dimensions







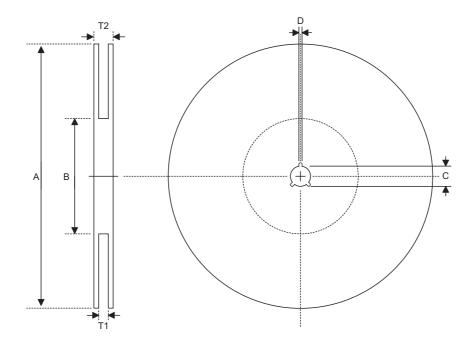
Sumb al	Dimensions in mil					
Symbol	Min.	Nom.	Max.			
А	394	_	419			
В	290	_	300			
С	14	_	20			
C'	697	_	713			
D	92	_	104			
E	_	50	_			
F	4	_	_			
G	32	_	38			
Н	4	_	12			
α	0°	_	10°			

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Product Tape and Reel Specifications

Reel Dimensions



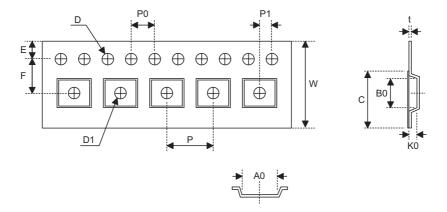
SOP 28W (300mil)

Symbol	Description	Dimensions in mm
А	Reel Outer Diameter	330±1.0
В	Reel Inner Diameter	62±1.5
С	Spindle Hole Diameter	13.0+0.5 -0.2
D	Key Slit Width	2.0±0.5
T1	Space Between Flange	24.8+0.3 -0.2
T2	Reel Thickness	30.2±0.2

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Carrier Tape Dimensions



SOP 28W (300mil)

Symbol	Description	Dimensions in mm
W	Carrier Tape Width	24.0±0.3
Р	Cavity Pitch	12.0±0.1
Е	Perforation Position	1.75±0.1
F	Cavity to Perforation (Width Direction)	11.5±0.1
D	Perforation Diameter	1.5+0.1
D1	Cavity Hole Diameter	1.5+0.25
P0	Perforation Pitch	4.0±0.1
P1	Cavity to Perforation (Length Direction)	2.0±0.1
A0	Cavity Length	10.85±0.1
В0	Cavity Width	18.34±0.1
K0	Cavity Depth	2.97±0.1
t	Carrier Tape Thickness	0.35±0.01
С	Cover Tape Width	21.3



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